

YDS-D3MA-IMX214 V5.0

13MP Sony IMX214 MIPI Interface Auto Focus Camera Module



Front View



Back View

Specifications

Camera Module No.	YDS-D3MA-IMX214 V5.0
Resolution	13MP
Image Sensor	IMX214
Sensor Type	1/3.06"
Pixel Size	1.12 um x 1.12 um
EFL	3.85 mm
F.NO	2.20
Pixel	4224 x 3136
View Angle	74.4°(DFOV) 62.7°(HFOV) 48.7°(VFOV)
Lens Dimensions	8.50 x 8.50 x 5.60 mm
Module Size	50.00 x 8.50 mm
Module Type	Auto Focus
Interface	MIPI
Auto Focus VCM Driver IC	FP5510
Lens Model	YDS-LENS-50013A1
Lens Type	650nm IR Cut
Operating Temperature	-20°C to +70°C
Mating Connector	BBR43-30KB533

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Parameters: <u>1</u> Sensor specifi Image Sensor: IMX214 Pixel: 1.12um×1.12um Lens Type: 1/3.06 Important Voltage Des (external power supply A		RoHS 0 SIGNAL 1 GND 2 GND 3 GND 4 GND 5 AFVDD2.8V 6 AFEN 7 SDA 8 DOVDD1.8V 9 SCL 10 DVDD1.0V 11 GND 12 XSHUTDOWN
Parameters: 1. Sensor specification: Image Sensor: IMX214 Pixel: 1.12um×1.12um Lens Type: 1/3.06 Important Voltage Description: DVDD1.0V (external power supply); A B		-
<pre>Z Lens spe FOV: 74.4°(D);62 F/NO.: 2.2 TV distortion: * Focal length: 3. Composition: 5P IR Cut Coating:</pre>	TOP VIEW	8.50±0.15 8.50±0.15 8.50±0.15 8.50±0.15 8.50±0.15 8.50±0.15 8.50±0.15 1.5 1.5 1.5 1.5 1.5 1.5 1.5
<u>_ens specification:</u> 74.4°(D);62.7°(H);48.7°(V); 2.2 Fortion: <1.5% ength: 3.85mm sition: SP+IR FILTER Coating: 650nm±10nm@50% C	0.12±0.03 FPC Adhesivele FCL, RA Steel Groundin STDE VIEW	$5.60 \pm 0.20 (h = 0.20 (h$
Designed By Checked By	9 <u>41</u> 7 	5.60±0.20(Micro Height) 5.40±0.20(Normal Height) 5.10±0.20(VCM Height) 5.10±0.020(VCM Height) 5.10±0.05 Steel Grounding
Kevin Aouly_Yan	TTOM VIEW	
In Third Angle	NOTE: 1.The dev 2.VCM Dri FP5510;	Version V1.0 V2.0 V5.0
Unit: mm Scale: 1:1	BOTTOM VIEW 2.VCM Driver IC and its I2C Address FP5510; 0x18h;	Information First Version Update the capture direction Extand FPC length
3 D3MA-IMX214 V5.0 Material: Sheet: 1 of 1 Version: 1 of 1 1/0	C Address:	Date 6-19-2018 7-2-2018 8-18-2022

SONY

[Product Brief]

Ver.1.0

IMX214

Diagonal 5.867mm (Type 1/3.06) 13M Pixel CMOS Image Sensor with Square Pixel for Color Cameras

Description

IMX214 is a diagonal 5.867mm(Type 1/3.06) 13M pixel CMOS active pixel type stacked image sensor with a square pixel array. It adopts Exmor RS[™] technology to achieve high speed image capturing by column parallel A/D converter circuits and high sensitivity and low noise image (comparing with conventional CMOS image sensor) through the backside illuminated imaging pixel structure. R, G, and B pigment primary color mosaic filter is employed. By introducing spacially varying exposure technology, high dynamic range still pictures and movies are achievable. It equips an electronic shutter with variable integration time. It operates with three power supply voltages: analog 2.7 V, digital 1.0V and 1.8 V for input/output interface and achieves low power consumption. IMX214 is designed for use in cellular phones or tablet devices*.

Functions and Features

- Back illuminated and stacked CMOS image sensor Exmor RS
- Single Frame High Dynamic Range (HDR) with equivalent full pixels.
- High signal to noise ratio (SNR).
- Full resolution @30fps (Nornmal / HDR).4K2K @30fps (Normal / HDR)1080p @60fps (Normal / HDR)
- ◆ Output video format of RAW10/8, COMP8/6
- Pixel binning readout and H/V sub sampling function
- Advanced Noise Reduction (Chroma noise reduction and luminance noise reduction)
- Independent flipping and mirroring.
- CSI 2 serial data output (MIPI 2lane/4lane, Max. 1.2Gbps/lane, DPHY spec. ver. 1.1 compliant)
- 2wire serial communication
- Two PLLs for independent clock generation for pixel control and data output interface.
- Advanced Noise Reduction.
- ◆ Dynamic Defect Pixel Correction.
- Zero shutter lag.
- Power on reset function
- Dual sensor synchronization operation.
- 8K bit of OTP ROM for users.
- Built in temperature sensor

NOTE)

1. When using this product for another application, Sony does not guarantee the quality and reliability of product. Therefore, don't use this for applications other than cellular phone and Tablet PCs. Consult your Sony sales representative if you have any questions.

Device Structure

- CMOS image sensor
- Image size
- Total number of pixels
- Number of effective pixels
- Number of active pixels
- Chip size

Unit cell size

: 4208 (H) ×3120 (V) approx. 13.13 M pixels : 6.100mm (H) × 4.524mm (V)

: Diagonal 5.867mm (Type 1/3.06)

: 4224 (H) ×3200(V) approx. 13.51M pixels

: 4224 (H) ×3136 (V)approx. 13.25 M pixels

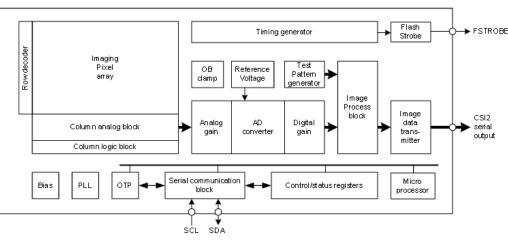
- : 1.12 μm (H) × 1.12 μm (V)
- Substrate material
- : 1.12 µ11 (□) * 1.12 : Silicon
- **Functional Description**

System Outline

IMX214 is a CMOS active pixel type image sensor which adopts the Exmor RS ™ technology to achieve high sensitivity, low noise and high speed image capturing. It is embedded with backside illuminated imaging pixel, low noise analog amplifier,

column parallel A/D converters which enables high speed capturing, digital amplifier, image binning circuit, timing control circuit for imaging size and frame rate, CSI2 image data high speed serial interface, PLL oscillator, and serial communication interface to control these functions.

Several additional image processing functions and peripheral circuits are also included for easy system optimization by the users. A one time programmable memory is embedded in the chip for storing the user data. It has 8 K-bit for users, 10 K-bit as a whole.



Block Diagram

Exmor RS

* Exmor RS is a trademark of Sony Corporation. The Exmor RS is a Sony's CMOS image sensor with high-resolution, high-performance and compact size by replacing a supporting substrate in Exmor R[™] which changed fundamental structure of Exmor[™] pixel adopted column parallel A/D converter to back-illuminated type, with layered chips formed signal processing circuits.

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Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits.



FP5510

10-Bit DAC 120mA VCM Driver with I²C Interface

Description

The FP5510 is a single 10-bit DAC with 120mA output current voice coil motor (VCM) driver, with an I^2 C-compatible serial interface that operates at clock rates up to 400kHz. Its supply operates from 2.3V to 3.6V.

The FP5510 incorporates with a power-on reset circuit, power-down function. Power-on reset circuit ensure when supply power up, DAC output is to 0V until valid write bit value takes place. In power down mode, the supply current is about 1μ A.

The FP5510 is designed for auto focus operation includes digital camera module, optical zoom camera phones and lens auto focus. The I^2C address of FP5510 is 0x18h.

The FP5510 with WLCSP package which it is suitable for reduced-space mounting in mobile phone and other portable applications.

Pin Assignments

6-Ball WLCSP

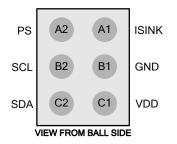


Figure 1. Pin Assignment of FP5510

Features

- Power Supply Voltage Rang: 2.3V to 3.6V
- VCM Driver for Auto-Focus
- 10-Bit Resolution Current Sinking of 120mA for VCM
- 2-Wire I²C Interface (1.8V Interface Compatible)
- Internal 4 Slope Control Mechanism
 - 1. Enhance Slope Control Mode
 - 2. One Step Mode
 - 3. Linear Slope Mode
 - 4. Two Step Slope Mode
- Power-Save Mode Current < 1µA
- Power On Reset (POR)
- Small Size: 0.7mm×1.1mm (6-Balls WLCSP)

Applications

- Digital Camera Module
- Cell Phone
- Lens Cover
- Web Camera

Ordering Information



Package Type
E2: WLCSP (6-Ball)

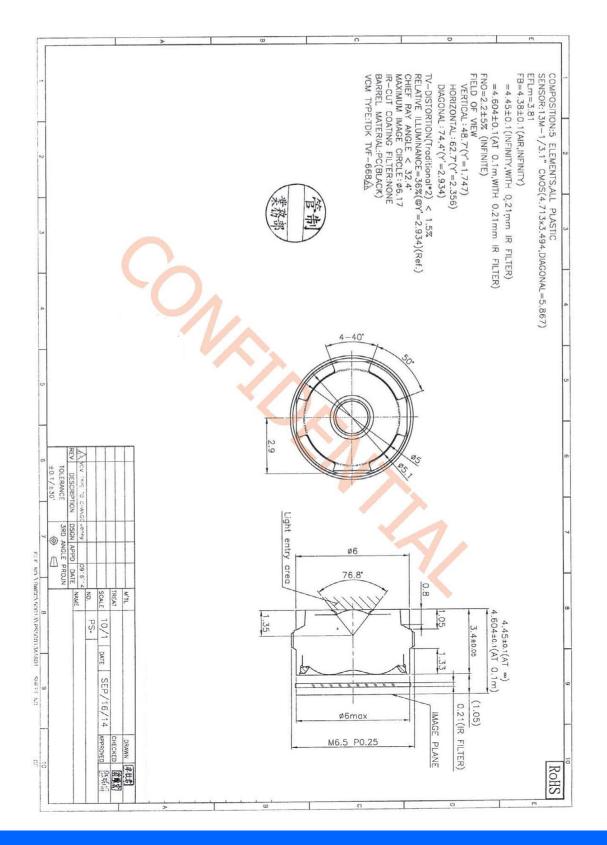
WLCSP-6 (0.7mmx1.1mm) Marking

Part Number	Product Code
FP5510E2	2

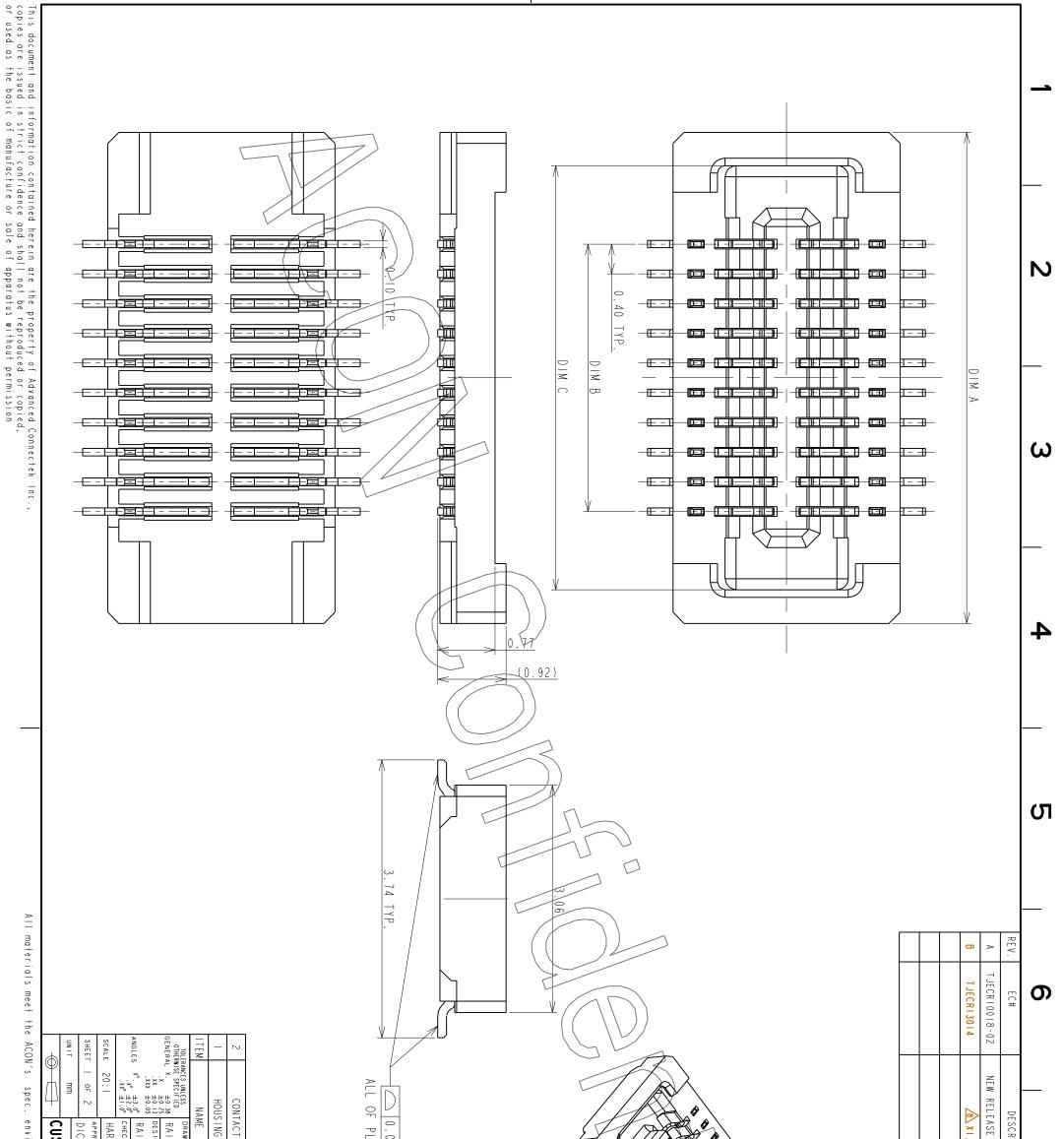


YDS-LENS-50013A1

DS

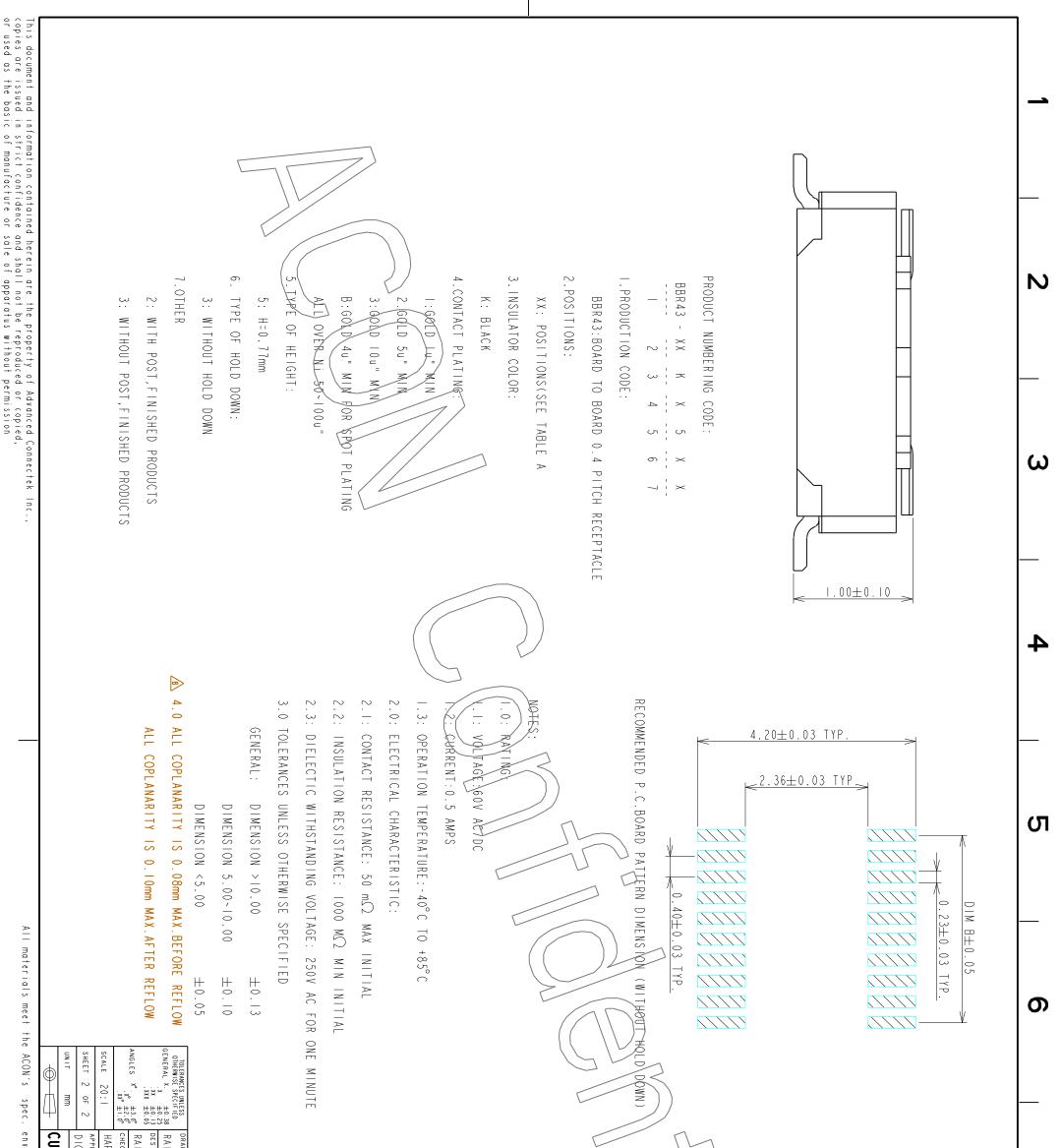


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Camera Module Pinout Definition Reference Chart

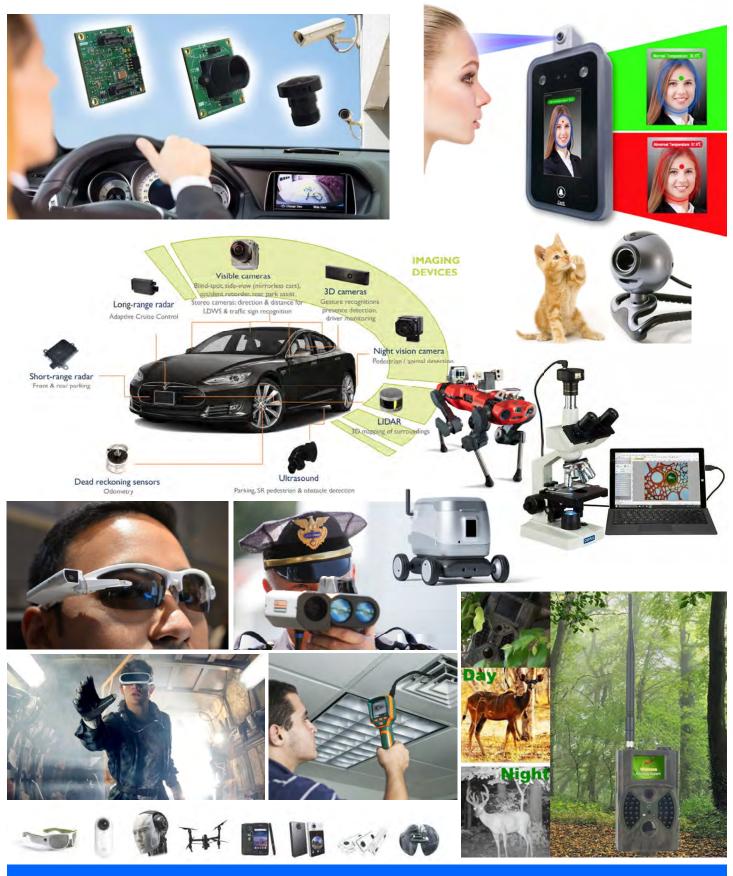
OmniVision Sony Samsung On-Semi Ap	tina Himax GalaxyCore PixArt SmartSens Sensors
Pin Signal	Description
DGND GND	ground for digital circuit
AGND	ground for analog circuit
PCLK DCK	DVP PCLK output
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor
MCLK XVCLK XCLK INCK	system input clock
RESET RST	reset active low with internal pull-up resistor
NC NULL	no connect
SDA SIO_D SIOD	SCCB data
SCL SIO_C SIOC	SCCB input clock
VSYNC XVS FSYNC	DVP VSYNC output
HREF XHS	DVP HREF output
DOVDD	power for I/O circuit
AFVDD	power for VCM circuit
AVDD	power for analog circuit
DVDD	power for digital circuit
STROBE FSTROBE	strobe output
FSIN	synchronize the VSYNC signal from the other sensor
SID	SCCB last bit ID input
ILPWM	mechanical shutter output indicator
FREX	frame exposure / mechanical shutter
GPIO	general purpose inputs
SLASEL	I2C slave address select
AFEN	CEN chip enable active high on VCM driver IC
MIPI Interface	
MDN0 DN0 MD0N DATA_N DM01N	MIPI 1st data lane negative output
MDP0 DP0 MD0P DATA P DM01P	MIPI 1st data lane positive output
MDN1 DN1 MD1N DATA2 N DMO2N	MIPI 2nd data lane negative output
MDP1 DP1 MD1P DATA2 P DM02P	MIPI 2nd data lane positive output
MDN2 DN2 MD2N DATA3 N DMO3N	MIPI 3rd data lane negative output
MDP2 DP2 MD2P DATA3 P DMO3P	MIPI 3rd data lane positive output
MDN3 DN3 MD3N DATA4 N DMO4N	MIPI 4th data lane negative output
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output
MCN CLKN CLK_N DCKN	MIPI clock negative output
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output
DVP Parallel Interface	
D0 D00 Y0	DV/P data output port 0
D1 D01 Y1	DVP data output port 0
D1 D01 Y1 D2 D02 Y2	DVP data output port 1 DVP data output port 2
D3 D03 Y3	
	DVP data output port 3
D4 D04 Y4 D5 D05 Y5	DVP data output port 4
	DVP data output port 5
D6 D06 Y6	DVP data output port 6
D7 D07 Y7	DVP data output port 7
D8 D08 Y8	DVP data output port 8
D9 D09 Y9	DVP data output port 9
D10 D010 Y10	DVP data output port 10
D11 D011 Y11	DVP data output port 11

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Cameras Applications

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Camera Reliability Test

	Reliability Inspect	ion Item	Testing Mathed	Acceptance Criteria	
Category		Item	Testing Method	Acceptance Criteria	
	Storage	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation	
E. Successful	Temperature	Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation	
	Operation	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation	
	Temperature	Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation	
Environmental	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation	
	Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation	
	Drop Test	Without Package 60cm	10 Times on Wood Floor	Electrically Functional	
	(Free Falling)	With Package 60cm	10 Times on Wood Floor	Electrically Functional	
		50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional	
Physical	Vibration Test	50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional	
Physical		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional	
	Cable Tensile Strength Test Loading Weight 4 kg 60 Seconds Cycling in 24 Hours		Tensile Testing Machine	Electrically Functional	
		Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional	
	ESD Test	Air Discharge 4 KV	ESD Testing Machine	Electrically Functional	
Electrical	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional	
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional	



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Camera Inspection Standard

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Inspection Item			Increation Mathed	Standard of Inspection
Category		Item	Inspection Method	Standard of Inspection
		Color	The Naked Eye	Major Difference is Not Allowed.
	FPC/ PCB	Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.
Appearance		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)
		Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed
	Holder	Gap	The Naked Eye	Meet the Height Standard
	Holdel	Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed
		Scratch	The Naked Eye	No Effect On Resolution Standard
	Long	Contamination	The Naked Eye	No Effect On Resolution Standard
	Lens	Oil Film	The Naked Eye	No Effect On Resolution Standard
		Cover Tape	The Naked Eye	No Issue On Appearance.
		No Communication	Test Board	Not Allowed
		Bright Pixel	Black Board	Not Allowed In the Image Center
		Dark Pixel	White board	Not Allowed In the Image Center
		Blurry	The Naked Eye	Not Allowed
		No Image	The Naked Eye	Not Allowed
		Vertical Line	The Naked Eye	Not Allowed
	Image	Horizontal Line	The Naked Eye	Not Allowed
Function		Light Leakage	The Naked Eye	Not Allowed
		Blinking Image	The Naked Eye	Not Allowed
		Bruise	Inspection Jig	Not Allowed
		Resolution	Chart	Follows Outgoing Inspection Chart Standard
		Color	The Naked Eye	No Issue
		Noise	The Naked Eye	Not Allowed
		Corner Dark	The Naked Eye	Less Than 100px By 100px
		Color Resolution	The Naked Eye	No Issue
		Height	The Naked Eye	Follows Approval Data Sheet
Dimen	sion	Width	The Naked Eye	Follows Approval Data Sheet
Dimen	1910[1	Length	The Naked Eye	Follows Approval Data Sheet
		Overall	The Naked Eye	Follows Approval Data Sheet

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YDSCAM Package Solutions

YDS Camera Module



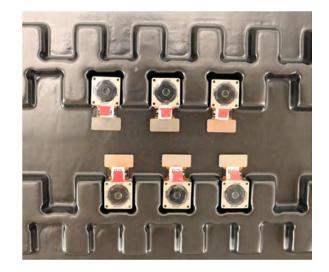
Tray with Grid and Space

Complete with Lens Protection Film



Place Cameras on the Tray





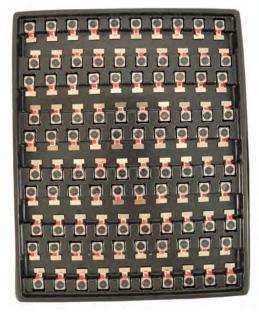
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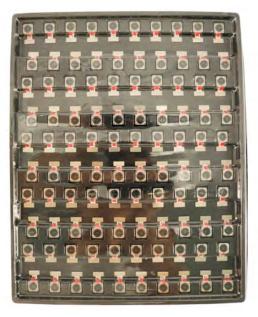
Full Tray of Cameras

DS



Place Tray into Anti-Static Bag

Cover Tray with Lid



Vacuum the Anti-Static Bag



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YDSCAM Package Solutions

Sealed Vacuum Anti-Static Bag with Labels

1. Model and Description 2. Quantity 3. Manufacturing Date Code 4. Caution



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YDSCAM Package Solutions

Place Foam Sheets Between Tray Bags



Place Foam Sheets and Trays into Box



Seal the Carbon Box



Foam Sheets are Larger Than Trays



Foam Sheets are Tightly Fitting in Box



Label the Carbon Shipping Box



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YDSCAM Package Solutions

USB Camera Module







Place Camera Sample into Anti-Static Bag

Place USB Cameras into Tray







Seal the Tray with Anti-Static Bag



Label the Carbon Shipping Box



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Complete with Lens Protection Film



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Place Camera Sample into Anti-Static Bag





Label the Sample Bags

Place Connectors into Anti-Static Bag



Place Connectors into Reel



Place Samples into the Carbon Box





Place Connectors into the Carbon Box



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YDS

Company YDSCAM

YingDeShun Co. Ltd. (YDS) was established in 2017, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. YDS is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

YDS provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. YDS specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.



Limited Warranty

YDS provides the following limited warranty if you purchased the Product(s) directly from YDS company or from YDS's website <u>www.YDSCAM.com</u>. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. YDS guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, YDS will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of YDS is solely limited to repair and/or replacement on the terms set forth above. YDS is not reliable or responsible for any subsequential events.



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YDS Strength

Y

Powerful Factory



Professional Service



Promised Delivery



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